Description (Continued)

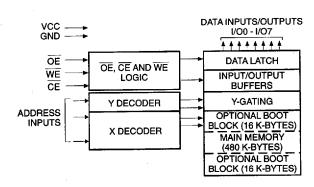
megabit design can easily accommodate both the AT29C040 and the AT29C040A with a few bytes of codes added to its existing programming software. Please refer to the software flow chart in this data sheet for details.

To allow for simple in-system reprogrammability, the AT29C040A does not require high input voltages for programming. Five-volt-only commands determine the operation of the device. Reading data out of the device is similar to reading from an EPROM. Reprogramming the AT29C040A is performed on

a sector basis; 256 bytes of data are loaded into the device and then simultaneously programmed.

During a reprogram cycle, the address locations and 256 bytes of data are internally latched, freeing the address and data bus for other operations. Following the initiation of a program cycle, the device will automatically erase the sector and then program the latched data using an internal control timer. The end of a program cycle can be detected by DATA polling of I/O7. Once the end of a program cycle has been detected, a new access for a read or program can begin.

Block Diagram



anne,

Device Operation

READ: The AT29C040A is accessed like an EPROM. When \overline{CE} and \overline{OE} are low and \overline{WE} is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state whenever \overline{CE} or \overline{OE} is high. This dual-line control gives designers flexibility in preventing bus contention.

BYTE LOAD: Byte loads are used to enter the 256 bytes of a sector to be programmed or the software codes for data protection. A byte load is performed by applying a low pulse on the $\overline{\text{WE}}$ or $\overline{\text{CE}}$ input with $\overline{\text{CE}}$ or $\overline{\text{WE}}$ low (respectively) and $\overline{\text{OE}}$ high. The address is latched on the falling edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever occurs last. The data is latched by the first rising edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$.

PROGRAM: The device is reprogrammed on a sector basis. If a byte of data within a sector is to be changed, data for the entire sector must be loaded into the device. Any byte that is not loaded during the programming of its sector will be erased to read FFh. Once the bytes of a sector are loaded into the device, they are simultaneously programmed during the internal programming period. After the first data byte has been loaded into the device, successive bytes are entered in the same manner. Each new byte to be programmed must have its high to low transition on WE (or CE) within 150 µs of the low to high transition of WE (or CE) of the preceding byte. If a high to low transition is not detected within 150 µs of the last low to high transition, the load period will end and the internal programming period will start. A8 to A18 specify the sector address. The sector address must be valid during each high to low transition of WE (or CE). A0 to A7 specify the byte address within the sector. The bytes may be loaded in any order; sequential loading is not required. Once a programming operation has been initiated, and for the duration of twc, a read operation will effectively be a polling operation.

SOFTWARE DATA PROTECTION: A software controlled data protection feature is available on the AT29C040A. Once the software protection is enabled a software algorithm must be issued to the device before a program may be performed. The software protection feature may be enabled or disabled by the user; when shipped from Atmel, the software data protection feature is disabled. To enable the software data protection, a series of three program commands to specific addresses with spe cific data must be performed. After the software data protection is enabled the same three program commands must begin each program cycle in order for the programs to occur. All software program commands must obey the sector program timing spec ifications. The SDP feature protects all sectors, not just a single sector. Once set, the software data protection feature remain active unless its disable command is issued. Power transition will not reset the software data protection feature, however the software feature will guard against inadvertent program cycle

After setting SDP, any attempt to write to the device without the three-byte command sequence will start the internal write timers. No data will be written to the device; however, for the duration of twc, a read operation will effectively be a polling operation.

After the software data protection's three-byte command code i given, a byte load is performed by applying a low pulse on the WE or CE input with CE or WE low (respectively) and OE high (continued)

AT29C040A

during power transitions.

Device Operation (Continued)

The address is latched on the falling edge of \overline{CE} or \overline{WE} , whichever occurs last. The data is latched by the first rising edge of \overline{CE} or \overline{WE} . The 256 bytes of data must be loaded into each sector by the same procedure as outlined in the program section under device operation.

HARDWARE DATA PROTECTION: Hardware features protect against inadvertent programs to the AT29C040A in the following ways: (a) VCC sense—if VCC is below 3.8 V (typical), the program function is inhibited. (b) VCC power on delay—once VCC has reached the VCC sense level, the device will automatically time out 5 ms (typical) before programming. (c) Program inhibit—holding any one of \overline{OE} low, \overline{CE} high or \overline{WE} high inhibits program cycles. (d) Noise filter—pulses of less than 15 ns (typical) on the \overline{WE} or \overline{CE} inputs will not initiate a program cycle.

PRODUCT IDENTIFICATION: The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product. In addition, users may wish to use the software product identification mode to identify the part (i.e. using the device code), and have the system software use the appropriate sector size for program operations. In this manner, the user can have a common board design for 256K to 4-megabit densities and, with each density's sector size in a memory map, have the system software apply the appropriate sector size.

For details, see Operating Modes (for hardware operation) or Software Product Identification. The manufacturer and device code is the same for both modes.

DATA POLLING: The AT29C040A features DATA polling to indicate the end of a program cycle. During a program cycle an attempted read of the last byte loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid on all outputs and the next cycle may begin. DATA polling may begin at any time during the program cycle.

TOGGLE BIT: In addition to DATA polling the AT29C040A provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the device will result in I/O6 toggling

Absolute Maximum Ratings*

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
All Input Voltages (including N.C. Pins) with Respect to Ground0.6 V to +6.25 V
All Output Voltages with Respect to Ground0.6 V to V _{CC} +0.6 V
Voltage on $\overline{\text{OE}}$ with Respect to Ground0.6 V to +13.5 V

between one and zero. Once the program cycle has completed, I/O6 will stop toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle.

OPTIONAL CHIP ERASE MODE: The entire device can be erased by using a six-byte software code. Please see Software Chip Erase application note for details.

BOOT BLOCK PROGRAMMING LOCKOUT: The AT29C040A has two designated memory blocks that have a programming lockout feature. This feature prevents programming of data in the designated block once the feature has been enabled. Each of these blocks consists of 16K bytes; the programming lockout feature can be set independently for either block. While the lockout feature does not have to be activated, it can be activated for either or both blocks.

These two 16K memory sections are referred to as boot blocks. Secure code which will bring up a system can be contained in a boot block. The AT29C040A blocks are located in the first 16K bytes of memory and the last 16K bytes of memory. The boot block programming lockout feature can therefore support systems that boot from the lower addresses of memory or the higher addresses. Once the programming lockout feature has been activated, the data in that block can no longer be erased or programmed; data in other memory locations can still be changed through the regular programming methods. To activate the lockout feature, a series of seven program commands to specific addresses with specific data must be performed. Please see Boot Block Lockout Feature Enable Algorithm.

If the boot block lockout feature has been activated on either block, the chip erase function will be disabled.

BOOT BLOCK LOCKOUT DETECTION: A software method is available to determine whether programming of either boot block section is locked out. See Software Product Identification Entry and Exit sections. When the device is in the software product identification mode, a read from location 00002H will show if programming the lower address boot block is locked out while reading location FFFF2H will do so for the upper boot block. If the data is FE, the corresponding block can be programmed; if the data is FF, the program lockout feature has been activated and the corresponding block cannot be programmed. The software product identification exit mode should be used to return to standard operation.

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Pin Capacitance $(f = 1 \text{ MHz}, T = 25^{\circ}\text{C})^{(1)}$

очражения	Тур	Max	Units	Conditions
Cin	4	6	pF	V _{IN} = 0 V
Соит	8	12	pF	Vout = 0 V

Note: 1. This parameter is characterized and is not 100% tested.

D.C. and A.C. Operating Range

	AT29C040A-12	AT29C040A-15	AT29C040A-20
Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C
Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
	5 V ± 10%	5 V ± 10%	5 V ± 10%
	Com.	Com. 0°C - 70°C Ind40°C - 85°C	Com. 0°C - 70°C 0°C - 70°C Ind40°C - 85°C -40°C - 85°C

Operating Modes

Mode	CE	ŌĒ	WE	Ai	1/0
Read	VIL	V _{IL}	ViH	Ai	Douт
Program ⁽²⁾	VIL	ViH	VIL	Ai	D _{IN}
Standby/Write Inhibit	ViH	X ⁽¹⁾	Х	X	High Z
Program Inhibit	Х	Х	V _{IH}		
Program Inhibit	Х	VIL	Х		
Output Disable	X	ViH	Х		High Z
Product Identification				A1-A18 = V _{IL} , A9 = V _H , ⁽³⁾ A0 = V _{IL}	Manufacturer Code ⁽⁴⁾
Hardware	VIL	VIL	V _{IH}	A1-A18 = V _{IL} , A9 = V _H , ⁽³⁾ A0 = V _{IH}	Device Code ⁽⁴⁾
(5)	·			A0 = V _{IL}	Manufacturer Code ⁽⁴⁾
Software ⁽⁵⁾				A0 = V _{IH}	Device Code ⁽⁴⁾

Notes: 1. X can be VIL or VIH.

2. Refer to A.C. Programming Waveforms.

3. $V_H = 12.0 \text{ V} \pm 0.5 \text{ V}$.

- 4. Manufacturer Code: 1F, Device Code: A4
- 5. See details under Software Product Identification Entry/Exit.

D.C. Characteristics

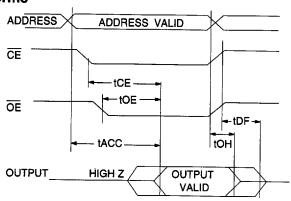
Symbol	Parameter	Condition		Min	Max	Units
ILI	Input Load Current	V _{IN} = 0 V to V _{CC}			10	μΑ
ILO	Output Leakage Current	$V_{I/O} = 0 \text{ V to VCC}$			10	μΑ
iLO			Com.		100	μΑ
ISB1	V _{CC} Standby Current CMOS	$\overline{CE} = V_{CC} - 0.3V$ to V_{CC}	Ind.		300	μА
ISB2	V _{CC} Standby Current TTL	CE = 2.0 V to Vcc			3	mA
Icc	Vcc Active Current	f = 5 MHz; lout = 0 mA			40	mA
VIL	Input Low Voltage		· · · · · · · · · · · · · · · · · · ·		0.8	V
VIH	Input High Voltage			2.0		V
Vol	Output Low Voltage	I _{OL} = 2.1 mA			.45	V
VoH1	Output High Voltage	loн = -400 μA		2.4		V
VOH2	Output High Voltage CMOS	I _{OH} = -100 μA; V _{CC} = 4.5 \	7	4.2		V

AT29C040A •

A.C. Read Characteristics

		AT29C040A-12		AT29C040A-15		AT29C040A-20		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Units
tacc	Address to Output Delay		120		150		200	ns
	CE to Output Delay		120		150		200	ns
toE (2)	OE to Output Delay	0	50	0	70	0	80	ns
t _{DF} (3,4)	CE or OE to Output Float	0	30	0	40	0	50	ns
tон	Output Hold from OE, CE or Address, whichever occurred first	0		0		0		ns

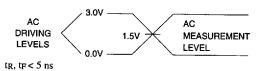
A.C. Read Waveforms^(1,2,3,4)



Notes:

- CE may be delayed up to tACC tCE after the address transition without impact on tACC.
- OE may be delayed up to tce toe after the falling edge of CE without impact on tce or by tACC - toe after an address change without impact on tACC.
- 3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first $(C_L = 5pF)$.
- 4. This parameter is characterized and is not 100% tested.

Input Test Waveforms and Measurement Level



Output Test Load



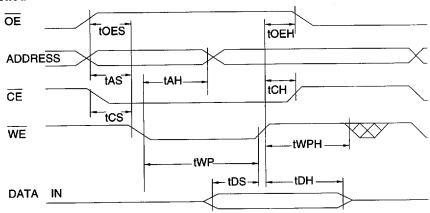


A.C. Byte Load Characteristics

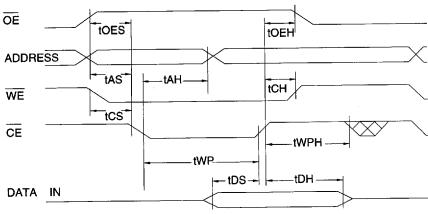
Symbol	Parameter	Min	Max	Units
tas, toes	Address, OE Set-up Time	10		` n\$
tан	Address Hold Time	50		ns
tcs	Chip Select Set-up Time	0		ns
tcH	Chip Select Hold Time	0		ns
twp	Write Pulse Width (WE or CE)	90		ns
tos	Data Set-up Time	50		ns
tDH,tOEH	Data, OE Hold Time	10		ns
twpH	Write Pulse Width High	100		ns

A.C. Byte Load Waveforms⁽¹⁾

WE Controlled



CE Controlled

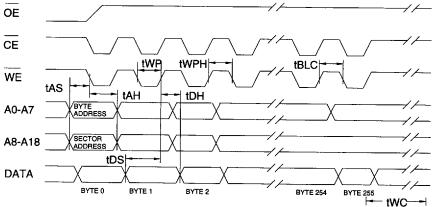


Note: 1. A complete sector (256 bytes) should be loaded using the waveforms shown in these byte load waveform diagrams.

AT29C040A

Symbol	Parameter	Min	Max	Units
twc	Write Cycle Time		10	ms
tas	Address Set-up Time	10		ns
tah	Address Hold Time	50		ns
tos	Data Set-up Time	50		ns
tон	Data Hold Time	10		ns
twp	Write Pulse Width	90		ns
tBLC	Byte Load Cycle Time		150	μѕ
twpH	Write Pulse Width High	100	· · · · · · · · ·	ns

Program Cycle Waveforms(1,2,3)



Notes: 1. A8 through A18 must specify the sector address during each high to low transition of \overline{WE} (or \overline{CE}). 2. \overline{OE} must be high when \overline{WE} and \overline{CE} are both low.

- 3. All bytes that are not loaded within the sector being programmed will be erased to FF.

Software Data Protection Enable Algorithm (1)

LOAD DATA

TO

SECTOR (256 BYTES) (4)

LOAD DATA AA TO ADDRESS 5555 **LOAD DATA 55** TO ADDRESS 2AAA LOAD DATA A0 TO WRITES ENABLED (2) ADDRESS 5555

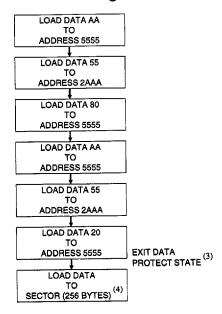
ENTER DATA

PROTECT STATE

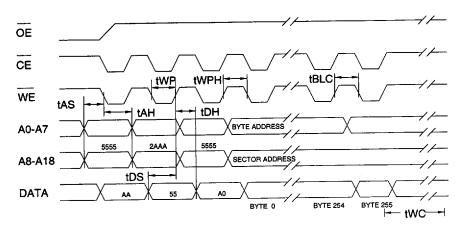
Notes for software program code:

- 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
- 2. Data Protect state will be activated at end of program cycle.
- 3. Data Protect state will be deactivated at end of program period.
- 4. 256 bytes of data MUST BE loaded.

Software Data Protection Disable Algorithm (1)



Software Protected Program Cycle Waveform (1,2,3)



- Notes: 1. A8 through A18 must specify the sector address during each high to low transition of WE (or CE) after the software code ha been entered.
 - 2. \overline{OE} must be high when \overline{WE} and \overline{CE} are both low.
 - 3. All bytes that are not loaded within the sector being programmed will be erased to FF.

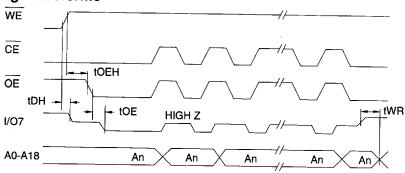
AT29C040A

Symbol	Parameter	Min	Тур	Max	Units
ton	Data Hold Time	10			ńs
toen	OE Hold Time	10			ns
toe	OE to Output Delay ⁽²⁾				ns
twR	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See toE spec in A.C. Read Characteristics.

Data Polling Waveforms



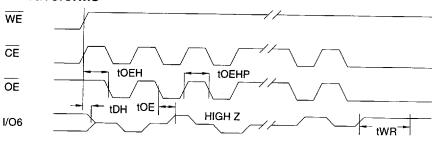
Toggle Bit Characteristics(1)

Symbol	Parameter	Min	Тур	Max	Units
tрн	Data Hold Time	10			ns
toeh .	OE Hold Time	10			ns
toe	OE to Output Delay ⁽²⁾				ns
tOEHP	OE High Pulse	150			ns
twn	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See toe spec in A.C. Read Characteristics.

Toggle Bit Waveforms (1,2,3)

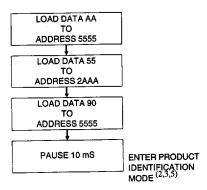


Notes: 1. Toggling either \overline{OE} or \overline{CE} or both \overline{OE} and \overline{CE} will operate toggle bit. The toehh specification must be met by the toggling input(s).

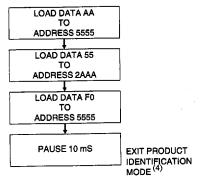
- 2. Beginning and ending state of I/O6 will vary.
- 3. Any address location may be used but the address should not vary.



Software Product Identification Entry



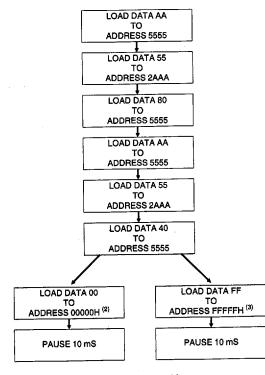
Software Product (1) Identification Exit



Notes for software product identification:

- 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
- A1 A18 = V_{IL}.
 Manufacture Code is read for A0 = V_{IL};
 Device Code is read for A0 = V_{IH}.
- The device does not remain in identification mode if powered down.
- 4. The device returns to standard operation mode.
- Manufacturer Code: 1F Device Code: A4

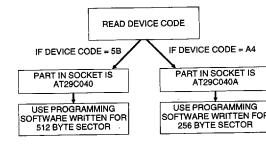
Boot Block Lockout Feature Enable Algorithm



Notes for boot block lockout feature enable:

- Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
- 2. Lockout feature set on lower address boot block.
- 3. Lockout feature set on higher address boot block.

AT29C040 and AT29C040A Software Flow Chart



AT29C040A

Ordering Information

tacc	lcc	(mA)	Ordering Code	Package	Operation Range
(ns)	Active	Standby	Ordering Code	1 ackage	Operation Hange
120	40	0.1	AT29C040A-12DC AT29C040A-12PC AT29C040A-12TC	32D6 32P6 32T	Commercial (0° to 70°C)
120	40	0.3	AT29C040A-12DI AT29C040A-12PI AT29C040A-12TI	32D6 32P6 32T	Industrial (-40° to 85°C)
150	40	0.1	AT29C040A-15DC AT29C040A-15PC AT29C040A-15TC	32D6 32P6 32T	Commercial (0° to 70°C)
150	40	0.3	AT29C040A-15DI AT29C040A-15FI AT29C040A-15PI	32D6 32F 32P6	Industrial (-40° to 85°C)
200	40	0.1	AT29C040A-20DC AT29C040A-20PC	32D6 32P6	Commercial (0° to 70°C)
200	40	0.3	AT29C040A-20DI AT29C040A-20FI AT29C040A-20PI	32D6 32F 32P6	Industrial (-40° to 85°C)

	Package Type				
32D6	32 Lead, 0.600" Wide, Non-Windowed, Ceramic Dual Inline Package (Cerdip)				
32F	32 Lead, Non-Windowed, Ceramic Bottom-Brazed Flat Package (Flatpack)				
32P6	32 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)				
32T	32 Lead, Thin Small Outline Package (TSOP)				

